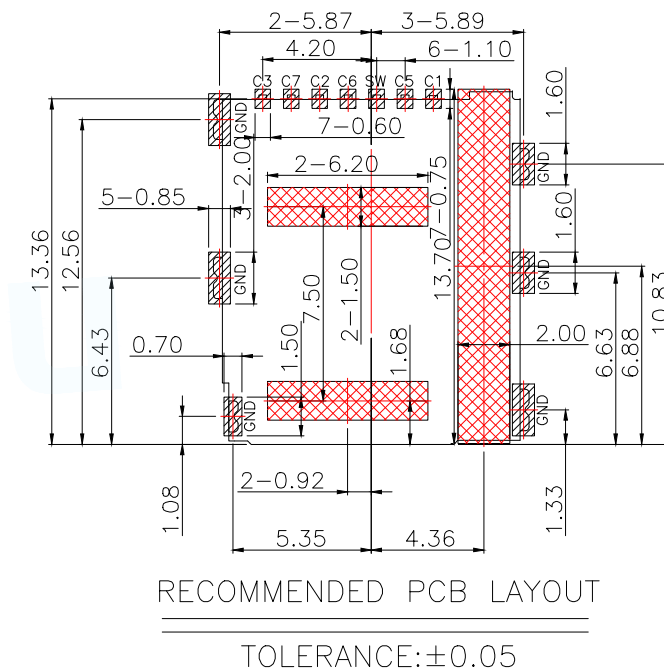
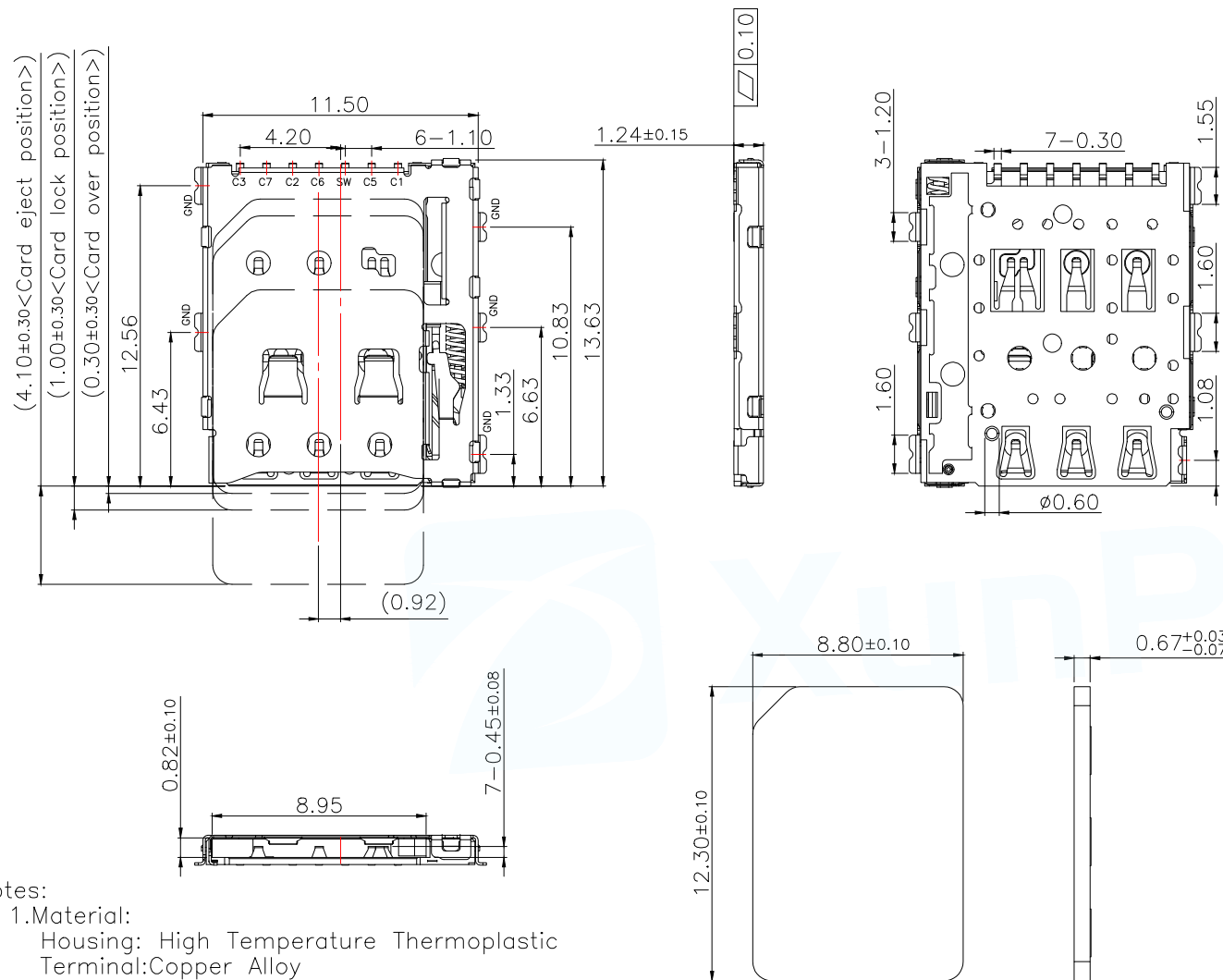




Notes:

1.Material:

Housing: High Temperature Thermoplastic
Terminal:Copper Alloy
Shell: Stainless Steel

2.Plating:

Terminal:50u" Ni Underplated Overall
G/F Plated On Contact Area
G/F Plated On Solder Area
Shell:30u" Ni Underplated Overall
G/F Plated On Contact Area And Solder Area

3.Technical Speciality:

Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance:1000M Ω Min.
Contact Resistance:100m Ω Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: -40 $^{\circ}$ C~+75 $^{\circ}$ C Humidity
80% R.H Max.

Connector Pin Assignment

NANO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
CD	Detection Switch

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: 1.24H Push-Push Nano-SIM卡座
DECIMALS:	ANGLES:		PAR SMN-308-ARSP7
.X:±0.30	X.:±3°		DWN
.XX:±0.20	X.X':±2°		CHKD
.XXX:±0.10			APVD
CUSTOMER COPY		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A

